



Secure ST solutions for identification

Focus MTCOS 2.5 roadmap



Agenda

1 MTCOS® Applications

2 Drivers for upgrading MTCOS®

3 MTCOS® Pro and Flex ID on ST chips

4 MTCOS® active features

5 Benefits of MTCOS® v 2.5

6 MTCOS® v 2.5 insight

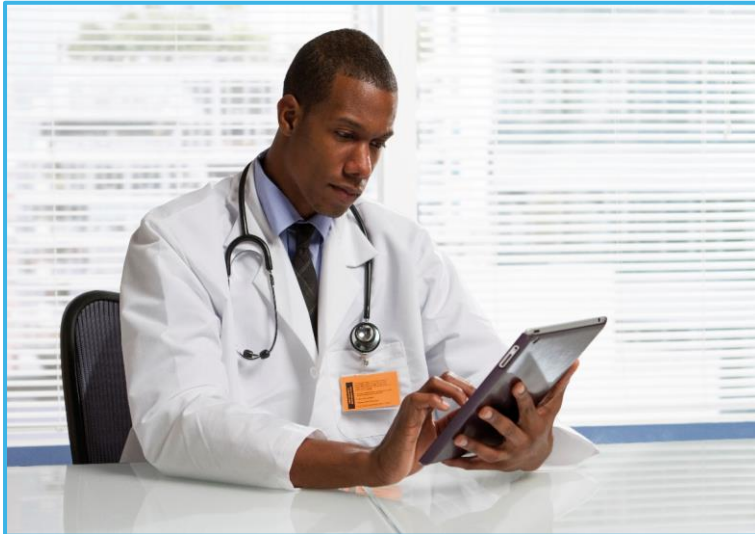
7 About MASKTECH

8 MASKTECH in the value chain

9 Possible business models

10 MTCOS® JavaCard

MTCOS® Applications



- eHealth
- eTransport
- eVoting
- ePurse
- eVehicle Registration
- eDriving License



- ePassport
- eID
- eResidence Permit



- Customized/ other MTCOS applications on request

Drivers for upgrading MTCOS®

- Proactive/ongoing MASKTECH software development
- Compliance with ICAO, ISO and other evolving regulations
- Interaction with government customers (gov. personalization systems)
- Participation in international interoperability tests
- Interoperability with latest border control equipment, e.g. ABCs
- Participation in international working groups
- Feedback from chip manufacturers



MTCOS® Pro and Flex ID on ST chips

MTCOS® v2.1 and v2.5: MTCOS® Flex ID is recommended for cost-efficient projects with limited memory and data processing needs

MTCOS Pro

MTCOS Flex ID

MTCOS® 2.1

ST23YR80
ROM masked | MTCOS v2.1 | 75kB FS
CC EAL 4+

MTCOS® 2.5

ST31G480
FLASH | MTCOS v2.5 | 180 kB FS
CC EAL 5+

ST31P450
FLASH | MTCOS v2.5 | 150 kB FS



MTCOS® active features 1/2

MTCOS® 2.5

MTCOS v2.2 +
PACE-ECDH-CAM | LDS2* |
VHBR (Very High Bit Rate) | Hidden Files

MTCOS® 2.2

MTCOS v2.1 +
PACE-ECDH-GM | AES up to 256 bit |
RSA up to 4096 bit

MTCOS® 2.1

MTCOS Base Features
BAC | Active Authentication | EAC-CA | EAC-TA |
Elliptic curves up to 512 Bit | RSA up to 3072 bit |
DH up to 2048 bit | SHA-1 up to -512

ICAO Standards

- BAC Basic Access Control
- EAC Extended Access Control
- SAC Supplemental Access Control
- CA Chip Authentication
- TA Terminal Authentication
- PACE Password Authenticated Connection Establishment
- CAM Chip Authentication Mapping

Cryptography

- RSA Rivest, Shamir and Adleman
- DH Diffie-Hellman
- ECDH Elliptic Curve Diffie-Hellman
- AES Advanced Encryption Standard
- 3DES Triple Data Encryption Algorithm

MTCOS® active features 2/2

MTCOS v2.2

PACE-ECDH-CAM | LDS2* | VHBR (Very High Bit Rate) |
Hidden Files

MTCOS v2.1

PACE-ECDH-GM | AES up to 256 bit |
RSA up to 4096 bit

MTCOS Base Features

BAC | Active Authentication | EAC-CA | EAC-TA |
Elliptic curves up to 512 bit | RSA up to 3072 bit |
DH up to 2048 bit | SHA-1 up to -512

MTCOS® 2.5

MTCOS® 2.2

MTCOS® 2.1

All MTCOS® versions are backward-compatible

Benefits of MTCOS® v2.5

Features can be activated for all passports or specific classes of books (e.g. Diplomats & Officials vs. Tourist)

Added government-controlled functionality

- Invisible EAC, SAC, LDS2 and other data groups (without anybody knowing about these added functionalities)
- Hidden Files

Added government-controlled flexibility

- Any or all features can be turned on at any point in the future, e.g. change from BAC ePassport to EAC ePassport (only personalization has to be adjusted)
- No impact on book inventory

Testing

- Newly activated feature(s) can be tested with in-house ePassport covers in the standard production environment, e.g. for Interop Tests

MTCOS® v2.5 insight

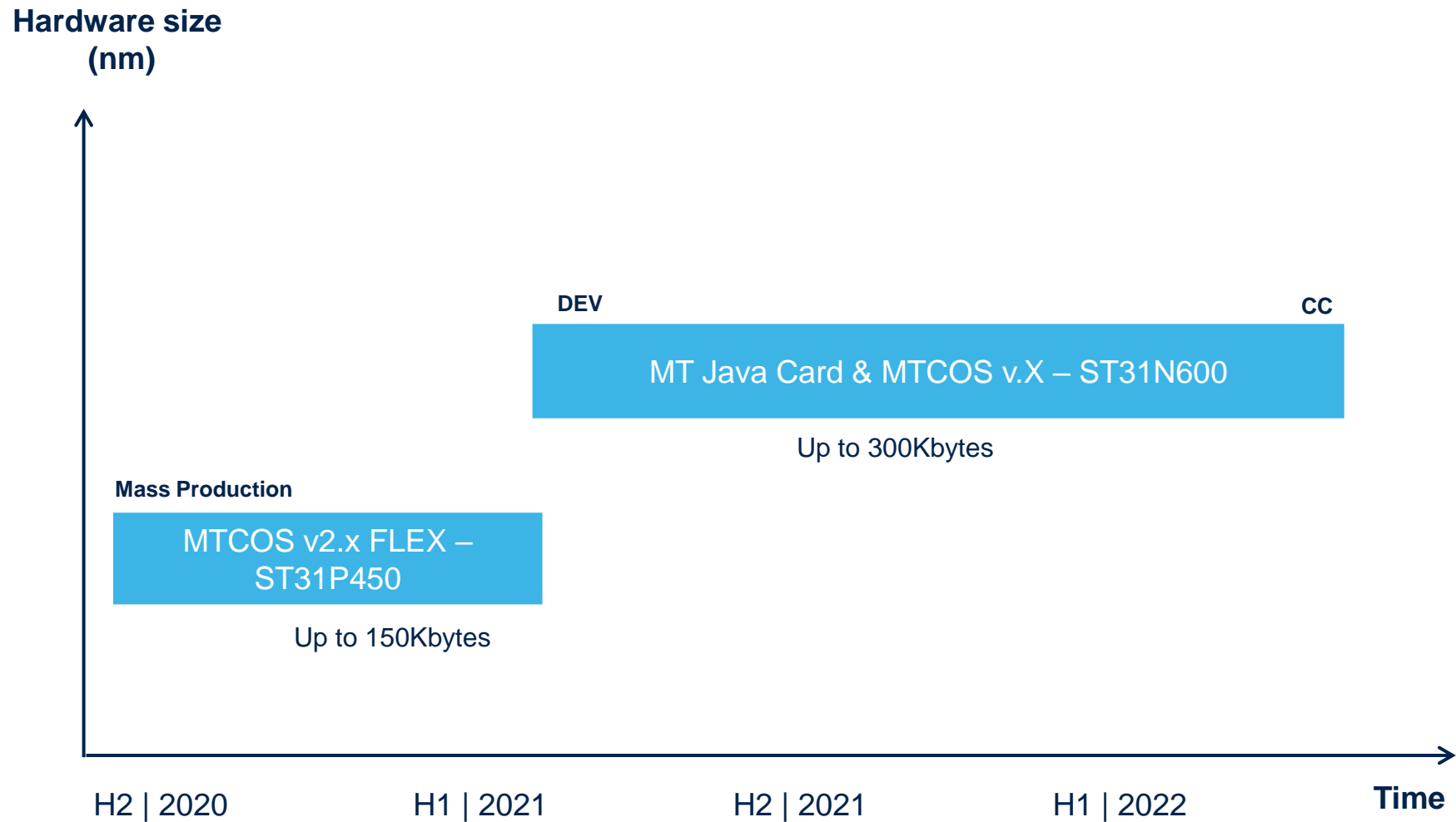
Recommended minimum chip size & performance data

	BAC	BAC + SAC	BAC + SAC + EAC	BAC + SAC + EAC + bio data ¹
Minimum chip size	64 Kbytes (36 Kbytes needed)	64 Kbytes (40 Kbytes needed)	80 Kbytes	140 Kbytes
MTCOS® V2.5 performance data	Write < 2 seconds	Write < 2 seconds	Write < 6 seconds	Write < 10 seconds ²
	Read < 1 second	Read < 1.5 seconds	Read < 6 seconds	Read < 10 seconds

(1) Large biometric data, e.g. iris or fingerprint data
 (2) LDS2 written in field (no impact on personalization time)

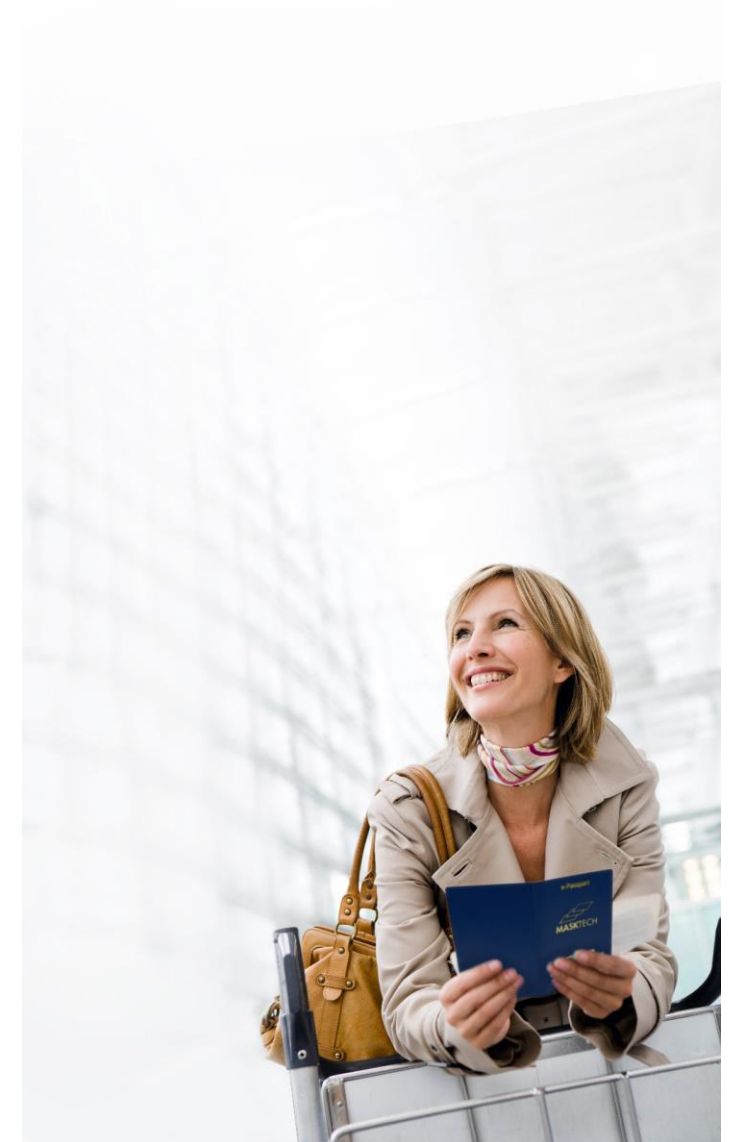


MTCOS® continuing future development on 40nm HW

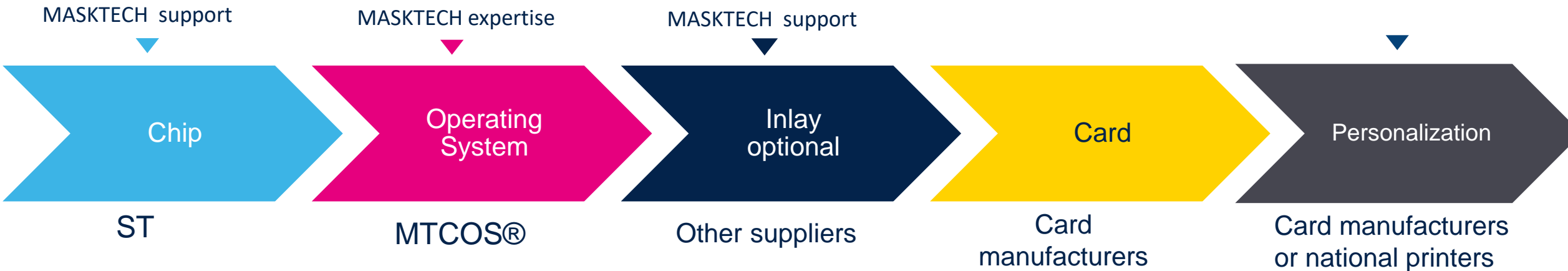
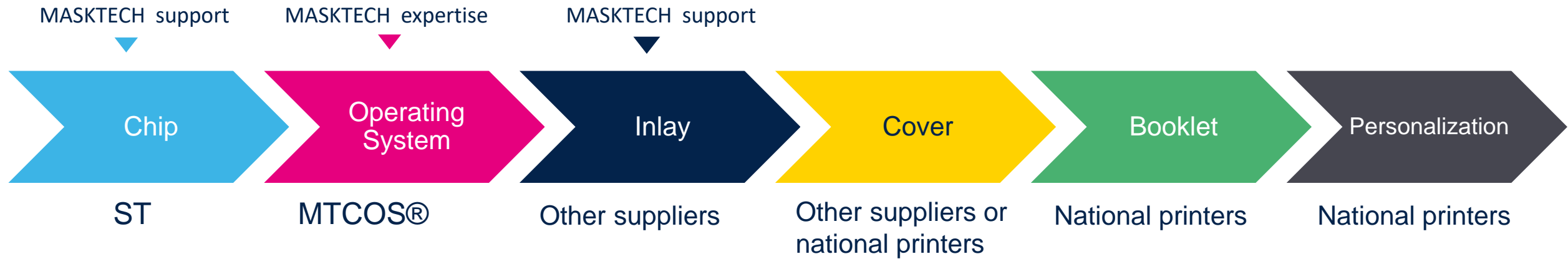


About MASKTECH

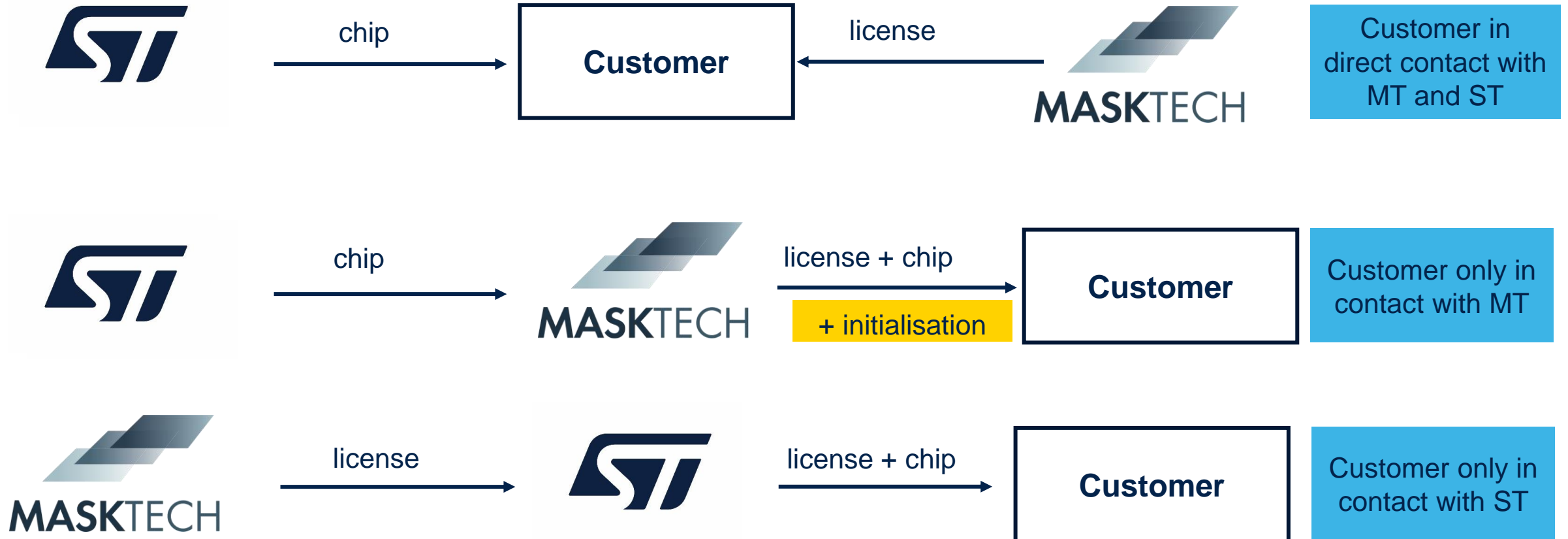
- Agile, responsive, proactive
- Independent, solely customer driven
- Guaranteed availability of OS for life of contract
- 50 government ePassport customers
 - > 250 million ePassports in use
- 350 million electronic MaskTech documents in circulation around the globe



MASKTECH in the value chain



Possible business models



MTCOS JavaCard



MASKTECH Java Card v 3.0.5

Platform & Feature Set

ST31N600 (ARM, 300kB Flash)

Java Card Classic Edition V3.0.5

MTCOS BIOS & Native API

Global Platform V 2.2.1 or higher (incl. eID extended packages)

Crypto Support for 3DES, AES, RSA, ECC

CC EAL5+

Applet Suite

ePassport (BAC, AA, EAC, SAC)

eDriving License (BAP, AA, EAC, SAC)

eID (eSign)

CC EAL4+/5+

MTCOS® Applet Suite

Supported applets



ePassport (BAC, AA, EAC, SAC)



eDrivingLicense (BAP, AA, EAC, SAC)



eID (ICAO + SSCD with PACE protection)



Customized applets

Global
Platform
personalization

- EAL4+/5+
- PP0055
- PP0056v2 (PP0068)
- PP0059 (SSCD)

MASKTECH own JC

ST31

Thank you

© STMicroelectronics - All rights reserved.

ST logo is a trademark or a registered trademark of STMicroelectronics International NV or its affiliates in the EU and/or other countries.

For additional information about ST trademarks, please refer to www.st.com/trademarks.

All other product or service names are the property of their respective owners.



life.augmented